

Linux Interface Specification Yocto recipe Start-Up Guide

User's Manual: Software

R-Car H3/M3 Series

All information contained in these materials, including products and product specifications, represents information on the product at the time of publication and is subject to change by Renesas Electronics Corp. without notice. Please review the latest information published by Renesas Electronics Corp. through various means, including the Renesas Electronics Corp. website (http://www.renesas.com).

Notice

- Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
- Renesas Electronics has used reasonable care in preparing the information included in this document, but Renesas Electronics
 does not warrant that such information is error free. Renesas Electronics assumes no liability whatsoever for any damages
 incurred by you resulting from errors in or omissions from the information included herein.
- 3. Renesas Electronics does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of Renesas Electronics products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
- 4. You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from such alteration, modification, copy or otherwise misappropriation of Renesas Electronics product.
- 5. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The recommended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below.
 - "Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots etc.
 - "High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control systems; anti-disaster systems; anti-crime systems; and safety equipment etc.

Renesas Electronics products are neither intended nor authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems, surgical implantations etc.), or may cause serious property damages (nuclear reactor control systems, military equipment etc.). You must check the quality grade of each Renesas Electronics product before using it in a particular application. You may not use any Renesas Electronics product for any application for which it is not intended. Renesas Electronics shall not be in any way liable for any damages or losses incurred by you or third parties arising from the use of any Renesas Electronics product for which the product is not intended by Renesas Electronics.

- 6. You should use the Renesas Electronics products described in this document within the range specified by Renesas Electronics, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. Renesas Electronics shall have no liability for malfunctions or damages arising out of the use of Renesas Electronics products beyond such specified ranges.
- 7. Although Renesas Electronics endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas Electronics product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or systems manufactured by you.
- 8. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please use Renesas Electronics products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. Renesas Electronics assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
- 9. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You should not use Renesas Electronics products or technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. When exporting the Renesas Electronics products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations.
- 10. It is the responsibility of the buyer or distributor of Renesas Electronics products, who distributes, disposes of, or otherwise places the product with a third party, to notify such third party in advance of the contents and conditions set forth in this document, Renesas Electronics assumes no responsibility for any losses incurred by you or third parties as a result of unauthorized use of Renesas Electronics products.
- 11. This document may not be reproduced or duplicated in any form, in whole or in part, without prior written consent of Renesas Electronics.
- 12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products, or if you have any other inquiries.
- (Note 1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its majority-owned subsidiaries.
- (Note 2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

Trademark

- · Linux® is a registered trademark or a trademark of Linus Torvalds in the United States and/or other countries.
- · ARM® is a registered trademark or a trademark of ARM Company in the United States and/or other countries.
- Windows and Windows Media are registered trademarks of Microsoft Corporation in the United States and other countries.
- · Other company names and product names mentioned herein are registered trademarks or trademarks of their respective owners.
- Registered trademark and trademark symbols (\circledR and \intercal M) are omitted in this document

How to Use This Manual

• [Readers]

This manual is intended for engineers who develop products which use the R-Car H3/M3 processor.

• [Purpose]

This manual is intended to give users an understanding of the functions of the R-Car H3/M3 processor device driver and to serve as a reference for developing hardware and software for systems that use this driver.

• [How to Read This Manual]

It is assumed that the readers of this manual have general knowledge in the fields of electrical

- engineering, logic circuits, microcontrollers, and Linux.
 - \rightarrow Read this manual in the order of the CONTENTS.
- To understand the functions of a multimedia processor for R-Car H3/M3
 - → See the R-Car H3/M3 User's Manual.
- To know the electrical specifications of the multimedia processor for R-Car H3/M3
 - → See the R-Car H3/M3 Data Sheet.

• [Conventions]

The following symbols are used in this manual.

Data significance: Higher digits on the left and lower digits on the right

Note: Footnote for item marked with Note in the text **Caution**: Information requiring particular attention

Remark: Supplementary information

Numeric representation: Binary ... ××××, 0b××××, or ××××B

Decimal ... ××××

Hexadecimal ... $0x \times \times \times$ or $\times \times \times \times H$ Data type: Double word ... 64 bits

Word ... 32 bits Half word ... 16 bits

Byte ... 8 bits

Table of Contents

Intro	oduction	
1. R	R-Car H3/M3 Linux BSP package files	2
1.1	Reference (R-Car H3/M3)	
2. E	Environmental Requirement	3
2.1	Setting of parts	3
2.2	Setting of dip switch	5
3. B	Building Instructions	7
3.1	In case of BSP + 3D Graphics + Multimedia package	9
3.2	In case of BSP + 3D Graphics (without Multimedia package)	16
3.3	In case of BSP Only	
4. W	Vriting of IPL/Secure	20
4.1	Writing data	
4.2	Dip-Switch	
4.3	How to write	20
4.4	IPL/Secure write	22
5. C	Confirm starting of U-Boot and Linux	23
6. E	Exporting Toolchains	26
7. M	Memory map	28
8. U	J-Boot command	35



Introduction

This start-up guide explains R-Car H3/M3 Yocto recipe package files, the system environments, the make method of kernel, the operating of U-Boot and so on.

This product R-Car H3/M3 Yocto recipe is a basic package to operate built-in Linux and basic middleware on the R-Car H3/M3 System Evaluation Board. Please contact Renesas Electronics person who provided this product to you in case of questions.

1. R-Car H3/M3 Linux BSP package files

This Yocto recipe will be taken

The U-Boot source code from:

git://github.com/renesas-rcar/u-boot.git

R-Car H3/M3 Linux source code from:

git://git.kernel.org/pub/scm/linux/kernel/git/horms/renesas-bsp.git

1.1 Reference (R-Car H3/M3)

Document name	Version
R-Car Series, 3rd Generation User's Manual: Hardware	Rev.0.53
R-CarH3-SiP System Evaluation Board Salvator-X Hardware Manual	Rev.1.03
R-CarM3-SiP System Evaluation Board Salvator-X Hardware Manual	Rev.1.03
R-CarH3-SiP/M3-SiP System Evaluation Board Salvator-XS Hardware Manual	Rev.2.00

Rev.2.19.0 Page 2 of 35 Apr. 26, 2017



2. Environmental Requirement

2.1 Setting of parts

Host PC and terminal software are necessary for the operation of this product. Furthermore, Ethernet cable is required to use NFS mount function. Please refer to Table 1.

Table 1 R-Car H3/M3 Linux BSP Environmental Requirement

Equipment	Explanation
Linux Host PC	Ubuntu 14.04 LTS (64bit) is recommended as OS. 32bit version is not supported.
	It is used as building and debugging environment.
	It is used as TFTP server and NFS server.
Windows Host PC	Windows 7 is recommended as OS.
	It is used as debugging environment.
	Terminal software and VCP driver are executed.
Terminal software	Please use following software.
	1) TeraTerm
	(Confirmed with Japanese version of Tera Term 4.87
	Available at http://sourceforge.jp/projects/ttssh2)
VCP driver	Please install in Windows Host PC.
	Execute CP210xVCPInstaller_x86/x64.exe for install before connect. USB become virtual COM port on terminal software. Please connect to CN25 (Serial-USB Bridge CP2102) on H3/M3 System Evaluation Board.
	(Available at http://www.silabs.com/products/mcu/Pages/USBtoUARTBridgeVCPDrivers.aspx)
TFTP server software	It is used when Hyper Flash is written by U-Boot or Image is downloaded.
NFS server software	It is used when File system is mounted by NFS.

Rev.2.19.0 Page 3 of 35

RENESAS

Recommended Environment

The following shows a Recommended Environment.

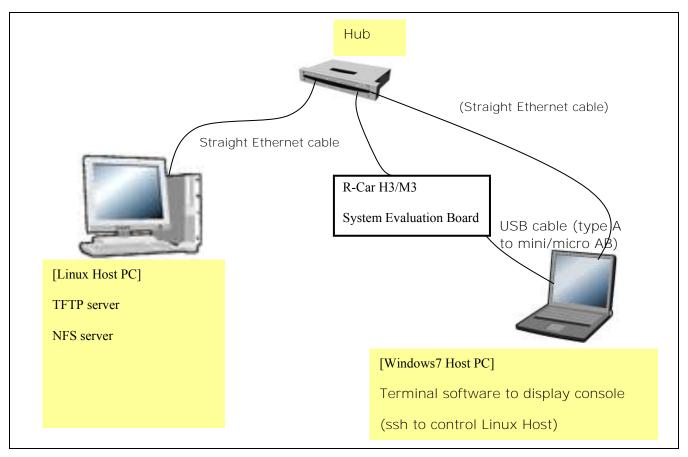


Figure 1. Recommended Environment for R-Car H3/M3 Linux BSP

Note) Functions in covered with () are optional.

2.2 Setting of dip switch

The setting of R-Car H3/M3 System Evaluation Board's dip switches is shown the following Table 2, Table 3, Table 4, Table 5.

For Salvator-X board, please refer to "R-CarH3-SiP System Evaluation Board RTP0RC7795SIPB0011S (Salvator-X) Setup Manual".

For Salvator-XS board, please refer to "R-CarH3/M3-SiP System Evaluation Board RTP0RC7795SIPB0012S (Salvator-XS) Setup Manual".

Table 2 setting of Dip switches (R-Car H3 Ver.2.0 / M3 Ver.1.1)

Switch	Switch	Pin1	Pin2	Pin3	Pin4	Pin5	Pin6	Pin7	Pin8
Number	Name								
SW1	QSPI-A	OFF	OFF	OFF	OFF	OFF	OFF	-	-
SW2	QSPI-B	OFF	OFF	OFF	OFF	OFF	OFF	-	-
SW3	QSPI-C		Set(ON)	-	-	-	-	-	-
SW13	QSPI-D	set	-		-	-	-	-	-
SW4	SOFTSW	OFF	OFF	OFF	OFF	-	-	-	-
SW5	GPIO/PWM1	set			-	-	-	-	-
SW6	GPIO/PWM2	set			-	-	-	-	-
SW7	DDRBKUP-A	set*1			-	-	-	-	-
SW8	DDRBKUP-B	OFF	OFF	OFF	OFF	-	-	-	-
SW9	TRST#			set	-	-	-	-	-
SW10	MODESW-A	ON	ON	ON	ON	ON	ON	OFF	ON
SW11	MODESW-B	OFF	ON	ON	ON*2	ON	ON	ON	ON
SW12	MODESW-C	OFF	ON	ON	ON	ON	ON	ON	ON
SW14	SSI78-M/S	set	-		-	-	-	-	-
SW15	USB-SW	set			-	-	-	-	-
SW16	SDHI0/DBG2-A	set	-		-	-	-	-	-
JP2	SDHI0/DBG2-B	set	-		-	-	-	-	-
SW28	VDDQVA_SD0	OFF	-	-	-	-	-	-	-
SW17	LVDS		set	-	-	-	-	-	-
SW20	TACTSW0		-	-	-	-	-	-	-
SW21	TACTSW1		-	-	-	-	-	-	-
SW22	TACTSW2		-	-	-	-	-	-	-
SW23	ACCSW	-	-	-	-	-	-	-	-
SW27	PRESET#		-	-	-	-	-	-	-
SW29	MIPI-SW	ON	ON	-	-	-	-	-	-
SW30	PHYAD	OFF	OFF	-	-	-	-	-	-

^{*1:} In after Yocto BSP v2.12.0, it is necessary to enable BKUP_TRG signal for Suspend to RAM, please set SW7 Pin-1.

Rev.2.19.0 Page 5 of 35 Apr. 26, 2017



^{*2:} If debugger is connected, please set SW11-4pin off.

Table 3 setting of Dip switches (R-Car H3 Ver.1.1)

Switch	Switch	Pin1	Pin2	Pin3	Pin4	Pin5	Pin6	Pin7	Pin8
Number	Name								
SW10	MODESW-A	ON	ON	OFF	ON	ON	ON	OFF	OFF
SW11	MODESW-B	OFF	ON	ON	ON*1	ON	ON	ON	ON
SW12	MODESW-C	OFF	ON						
Other	Same as H3 Ver.2.0								

^{*1:} If debugger is connected, please set SW11-4pin off.

Table 4 setting of Dip switches (R-Car H3 Ver.1.0)

Switch	Switch	Pin1	Pin2	Pin3	Pin4	Pin5	Pin6	Pin7	Pin8
Number	Name								
SW10	MODESW-A	ON	ON	OFF	OFF	ON	ON	OFF	ON
SW11	MODESW-B	OFF	ON	ON	ON*1	ON	ON	ON	ON
SW12	MODESW-C	OFF	ON	OFF	OFF	ON	ON	ON	ON
Other	Same as H3 Ver.2.0						•		•

^{*1:} If debugger is connected, please set SW11-4pin off.

Table 5 setting of Dip switches (R-Car M3 Ver.1.0)

Switch	Switch	Pin1	Pin2	Pin3	Pin4	Pin5	Pin6	Pin7	Pin8
Number	Name								
SW10	MODESW-A	ON	ON	ON	ON	ON	ON	OFF	OFF
SW11	MODESW-B	OFF	ON	ON	ON*1	ON	ON	ON	ON
SW12	MODESW-C	OFF	ON						
Other	Same as H3 Ver.2.0		•	•	•	•			•

^{*1:} If debugger is connected, please set SW11-4pin off.

Rev.2.19.0 Page 6 of 35



3. Building Instructions

You can build BSP by using Yocto Project. Please execute following steps in \${WORK} directory on Linux Host PC. Filesystem by making following instruction is the one for testing current BSP package in Renesas. Please note that Renesas has not been verified with any other build configuration or modified recipes except "core-image-weston" configuration which is based on upstream Yocto Project deliverables and some additional packages correspond to gstreamer.

Note) Renesas executed following instructions with clean \${WORK}/build directory. You may use wipe-sysroot and/or bitbake -c cleansstate to reflect modifications of configuration files for Recipe as in open source Yocto Project's standards, however Renesas strongly recommend to use recipe with clean \${WORK}/build directory for each configurations because there are some implicit dependency for header files exist to keep compatibility between application build scheme with/without proprietary software.

Step 1 installation of required commands

Ubuntu is used as Linux Host PC since Yocto Project Quick Start specifies Ubuntu as one of the distribution. In case of that you can install the required commands as follows.

Please refer to http://www.yoctoproject.org/docs/current/yocto-project-qs/yocto-project-qs.html for detail.

\$ sudo apt-get install gawk wget git-core diffstat unzip texinfo gcc-multilib \ build-essential chrpath socat libsdl1.2-dev xterm python-crypto

Note) There is a bitbake command in \${WORK}/poky/scripts/. Command path is available after step 6.

Note) When you use terminal interactions to build such as menuconfig under non-X terminal (ssh, etc.), please install "screen" command package to Host PC

Note) Please set up user name and e-mail in Git. You can set up with 'git config --global'. Please refer to online manual for git command.

Step 2 download of required files

Required files (poky, meta-linaro) are downloaded by git clone.

\$ cd \${ WORK}

\$ git clone git://git.yoctoproject.org/poky

\$ git clone git://git.linaro.org/openembedded/meta-linaro.git

\$ git clone git://git.openembedded.org/meta-openembedded

\$ git clone git://github.com/renesas-rcar/meta-renesas.git

Rev.2.19.0 Page 7 of 35 Apr. 26, 2017



Step 3 checkout

Please checkout available version of each git clone.

```
$ cd ${ WORK} /poky

$ git checkout -b tmp yocto-2.1.2

$ cd ${ WORK} /meta-linaro

$ git checkout -b tmp 2f51d38048599d9878f149d6d15539fb97603f8f

$ cd ${ WORK} /meta-openembedded

$ git checkout -b tmp 55c8a76da5dc099a7bc3838495c672140cedb78e

$ cd ${ WORK} /meta-renesas

$ git checkout -b tmp 95cb48ba09bc7e55fd549817e3e26723409e68d5
```

Note) tmp is a temporary name of a local branch. We can use checkout command without branch. Please note that HEAD refers directly to commit (detached HEAD).

Step 4 apply patch file

Because Renesas proprietary software is using linaro-GCC, it needs to apply. Please perform patch command.

```
$ cd ${ WORK} / meta-renesas
$ export PATCH_DIR=meta-rcar-gen3/docs/sample/patch/patch-for-linaro-gcc
$ patch -p1 < \
    ${ PATCH_DIR} /0001-rcar-gen3-add-readme-for-building-with-Linaro-Gcc.patch
$ unset PATCH_DIR</pre>
```

RENESAS

3.1 In case of BSP + 3D Graphics + Multimedia package

When you use proprietary Multimedia and 3D Graphics software from Renesas, please execute as following steps. Otherwise please skip to section 3.2 or 3.3.

Step 5 copy proprietary software into recipe directory structure

To use licensed 3D graphics software and Multimedia package from Renesas, please copy deliverables of those software into recipe directory structure. Renesas provide shell script to copy those software.

```
Copy All Proprietary Software Packages to ${PKGS_DIR}:

$ mkdir ${PKGS_DIR}

$ cp <zip of Proprietary Software Package> ${PKGS_DIR}

Install them into recipe directory structure by shell script:

$ cd ${WORK} / meta-renesas

$ sh \

meta-rcar-gen3/docs/sample/copyscript/copy_proprietary_softwares.sh \

${PKGS_DIR}
```

Note) Subdirectory is not supporting in ${PKGS_DIR}$. Please store all packages on the root of ${PKGS_DIR}$. Note) Please use regular alphanumeric file name ([A-Za-z0-9_] e.g.) for ${PKGS_DIR}$ due to restrictions of current copy script.

Step 6 execute source command

Please execute source command with oe-init-build-env for setting environment.

```
$ cd ${ WORK}
$ source poky/oe-init-build-env
```

Step 7 copy bblayers.conf and local.conf

Please copy configuration files from deliverables.

```
$ cp ${ WORK} / meta-renesas / meta-rcar-gen3 / docs / sample / conf / < supported board name > / linaro-gcc / mmp / * .conf . / conf / .
```

Note) <supported board name> is the one of the following: salvator-x

Step 8 enable 3D Graphics and Multimedia package to install GSX modules

To enable 3D Graphics packages which use GSX, please overwrite local.conf as following instructions or modify local.conf as descriptions in \${WORK}/meta-renesas/meta-rear-gen3/README.proprietary

```
To install GSX kernel module:

Overwrite local.conf

$ cp conf/local-wayland.conf conf/local.conf (For Wayland)
```

Step 9 enable Multimedia package

Please modify configurations in \${WORK}/build/conf/local.conf by following instructions

Note) Please refer to \${WORK}/meta-renesas/meta-rcar-gen3/README.proprietary

The following standard multimedia packages are enabled

No.	Functions	Explanation
1	MMNGR	Memory manager driver & shared libraries
2	VSPM	VSP driver & FDP driver & shared libraries
3	VSP2	VSP2 driver
4	OMX	OMX common parts

To enable optional multimedia functions, please add DISTRO_FEATURES_append to $\{WORK\}$ /build/conf/local.conf as DISTRO_FEATURES_append = "<function name>".

Note) These configurations exist near the end of local.conf.

Note) DISTRO_FEATURES_append are commented out by the default. To enable functions, please uncomment it.

For example
[Disable]

#DISTRO_FEATURES_append = " h263dec_lib"

[Enable (default)]

DISTRO_FEATURES_append = " h263dec_lib"

Rev.2.19.0 Page 10 of 35 Apr. 26, 2017 The following list is package name to enable/disable as optional multimedia functions

No.	Function name	Default value	Explanation
1	h264dec_lib	Enable	H264 decoder library RTM0AC0000XV264D30SL40C
2	h264enc_lib	Disable	H264 encoder library RTM0AC0000XV264E30SL40C
3	h265dec_lib	Disable	H265 decoder library RTM0AC0000XV265D30SL40C
4	mpeg2dec_lib	Disable	MPEG2 decoder library RTM0AC0000XVM2VD30SL40C
5	mpeg4dec_lib	Disable	MPEG4 decoder library RTM0AC0000XVM4VD30SL40C
6	vc1dec_lib	Disable	VC-1 decoder library RTM0AC0000XVVC1D30SL40C
7	h263dec_lib	Disable	H263 decoder library RTM0AC0000XV263D30SL40C
8	divxdec_lib	Disable	DivX decoder library RTM0AC0000XVDVXD30SL40C
9	rvdec_lib	Disable	RealVideo decoder library RTM0AC0000XVRLVD30SL40C
10	aaclcdec_lib	Enable	AAC-LC decoder library RTM0AC0000XAAACD30SL40C
11	aaclcdec_mdw	Enable	AAC-LC 2ch decoder middleware library RTM0AC0000ADAACMZ1SL40C
12	aacpv2dec_lib	Disable	aacPlus V2 Decoder Library RTM0AC0000XAAAPD30SL40C
13	aacpv2dec_mdw	Disable	aacPlus V2 Decoder Middleware Library RTM0AC0000ADAAPMZ1SL40C
14	mp3dec_lib	Disable	MP3 decoder library RTM0AC0000XAMP3D30SL40C
15	mp3dec_mdw	Disable	MP3 decoder middleware library RTM0AC0000ADMP3MZ1SL40C
16	wmadec_lib	Disable	WMA decoder library RTM0AC0000XAWMAD30SL40C
17	wmadec_mdw	Disable	WMA decoder middleware library RTM0AC0000ADWMAMZ1SL40C
18	aaclcenc_lib	Disable	AAC-LC encoder library RTM0AC0000XAAACE30SL40C
19	aaclcenc_mdw	Disable	AAC-LC encoder middleware library RTM0AC0000AEAACMZ1SL40C
20	flacdec_lib	Disable	FLAC decoder library RTM0AC0000XAFLAD30SL40C
21	alacdec_lib	Disable	ALAC decoder library RTM0AC0000XAALAD30SL40C
22	dddec_lib	Disable	Dolby(R) Digital decoder library RTM0AC0000XADD5D30SL40C
23	dddec_mdw	Disable	Dolby(R) Digital decoder middleware library RTM0AC0000ADDD5MZ1SL40C

Rev.2.19.0 Apr. 26, 2017

3. Building Instructions

No.	Function name	Default value	Explanation
24	cmsbcm	Disable	Basic Color Management Middleware for Linux RTM0AC0000JRCMBCV0SL40C
25	cmsblc	Disable	CMM3 Backlight Control Middleware for Linux RTM0AC0000JRCMBLC0SL40C
26	cmsdgc	Disable	VSP2 Dynamic Gamma Correction Middleware for Linux RTM0AC0000JRCMDGV0SL40C
27	adsp	Disable	ADSP Interface for Linux RCG3AHIFL4001ZDP
28	avb	Disable	Ether-AVB

Rev.2.19.0 Page 12 of 35 Apr. 26, 2017



The following list is dependent package name

No.	Function name	Type Name	Dependent Packages
1	h264dec_lib	RTM0AC0000XV264D30SL40C	RTM0AC0000XVCMND30SL40C RTM0AC0000XCMCTL30SL40C RCG3VUDRL4001ZDO
2	h264enc_lib	RTM0AC0000XV264E30SL40C	RTM0AC0000XVCMNE30SL40C RTM0AC0000XCMCTL30SL40C RCG3VUDRL4001ZDO
3	h265dec_lib	RTM0AC0000XV265D30SL40C	RTM0AC0000XVCMND30SL40C RTM0AC0000XCMCTL30SL40C RCG3VUDRL4001ZDO
4	mpeg2dec_lib	RTM0AC0000XVM2VD30SL40C	RTM0AC0000XVCMND30SL40C RTM0AC0000XCMCTL30SL40C RCG3VUDRL4001ZDO
5	mpeg4dec_lib	RTM0AC0000XVM4VD30SL40C	RTM0AC0000XVCMND30SL40C RTM0AC0000XCMCTL30SL40C RCG3VUDRL4001ZDO
6	vc1dec_lib	RTM0AC0000XVVC1D30SL40C	RTM0AC0000XVCMND30SL40C RTM0AC0000XCMCTL30SL40C RCG3VUDRL4001ZDO
7	h263dec_lib	RTM0AC0000XV263D30SL40C	RTM0AC0000XVCMND30SL40C RTM0AC0000XCMCTL30SL40C RCG3VUDRL4001ZDO
8	divxdec_lib	RTM0AC0000XVDVXD30SL40C	RTM0AC0000XVCMND30SL40C RTM0AC0000XCMCTL30SL40C RCG3VUDRL4001ZDO
9	rvdec_lib	RTM0AC0000XVRLVD30SL40C	RTM0AC0000XVCMND30SL40C RTM0AC0000XCMCTL30SL40C RCG3VUDRL4001ZDO
10	aaclcdec_lib	RTM0AC0000XAAACD30SL40C	RTM0AC0000XCMCTL30SL40C RTM0AC0000XACMND30SL40C RTM0AC0000ADAACMZ1SL40C
11	aaclcdec_mdw	RTM0AC0000ADAACMZ1SL40C	-
12	aacpv2dec_lib	RTM0AC0000XAAAPD30SL40C	RTM0AC0000XCMCTL30SL40C RTM0AC0000XACMND30SL40C RTM0AC0000ADAAPMZ1SL40C
13	aacpv2dec_mdw	RTM0AC0000ADAAPMZ1SL40C	-
14	mp3dec_lib	RTM0AC0000XAMP3D30SL40C	RTM0AC0000XCMCTL30SL40C RTM0AC0000XACMND30SL40C RTM0AC0000ADMP3MZ1SL40C
15	mp3dec_mdw	RTM0AC0000ADMP3MZ1SL40C	-
16	wmadec_lib	RTM0AC0000XAWMAD30SL40C	RTM0AC0000XCMCTL30SL40C RTM0AC0000XACMND30SL40C RTM0AC0000ADWMAMZ1SL40C

Rev.2.19.0 Apr. 26, 2017

3. Building Instructions

No.	Function name	Type Name	Dependent Packages
17	wmadec_mdw	RTM0AC0000ADWMAMZ1SL40C	-
18	aaclcenc_lib	RTM0AC0000XAAACE30SL40C	RTM0AC0000XCMCTL30SL40C RTM0AC0000XACMND30SL40C RTM0AC0000AEAACMZ1SL40C
19	aaclcenc_mdw	RTM0AC0000AEAACMZ1SL40C	-
20	flacdec_lib	RTM0AC0000XAFLAD30SL40C	RTM0AC0000XCMCTL30SL40C RTM0AC0000XACMND30SL40C RCG3AFLDL4001ZDO
21	alacdec_lib	RTM0AC0000XAALAD30SL40C	RTM0AC0000XCMCTL30SL40C RTM0AC0000XACMND30SL40C RCG3AFLDL4001ZDO
22	dddec_lib	RTM0AC0000XADD5D30SL40C	RTM0AC0000XCMCTL30SL40C RTM0AC0000XACMND30SL40C RTM0AC0000ADDD5MZ1SL40C
23	dddec_mdw	RTM0AC0000ADDD5MZ1SL40C	-
24	cmsbcm	RTM0AC0000JRCMBCV0SL40C	-
25	cmsblc	RTM0AC0000JRCMBLC0SL40C	-
26	cmsdgc	RTM0AC0000JRCMDGV0SL40C	-
27	adsp	RCG3AHIFL4001ZDP	RCG3AHPDL4001ZDO RCG3AHFWN0101ZDP
28	avb	-	-

Rev.2.19.0 Page 14 of 35 Apr. 26, 2017



Step 10 select SoC

To select SoC, please set SOC_FAMILY to \${WORK}/build/conf/local.conf as SOC_FAMILY = "<soc type name>".

```
[H3]

SOC_FAMILY = "r8a7795"

[M3]

SOC_FAMILY = "r8a7796"
```

Step 11 building with bitbake

Please build as follows. The file system (core-image-weston-<supported board name>.tar.bz2) is created in \${WORK}/build/tmp/deploy/images/<supported board name>/ directory.

Note) < supported board name > is the one of the following: salvator-x

Note) Build by bitbake might need several hours under the influence of Linux Host PC performance and network environment.

Note) The bitbake downloads some package while building. Then the bitbake might stop for network timeout or link error. In this case, please get applicable package in \${WORK}/build/downloads directory whenever build stops by wget command, or please review timeout definitions of package download (wget, etc.) described in \${WORK}/poky/meta/conf/bitbake.conf.

\$ cd \${ WORK} / build
\$ bitbake core-image-weston (for Wayland)

3.2 In case of BSP + 3D Graphics (without Multimedia package)

When you use licensed 3D Graphics software but will not use proprietary Multimedia software from Renesas, please execute as following steps. Otherwise please skip to section 3.3.

Step 5 copy proprietary software into recipe directory structure

To use licensed 3D graphics software and Multimedia package from Renesas, please copy deliverables of those software into recipe directory structure. Renesas provide shell script to copy those software.

```
Copy All Proprietary Software Packages to ${PKGS_DIR}:

$ mkdir ${PKGS_DIR}

$ cp <zip of Proprietary Software Package> ${PKGS_DIR}

Install them into recipe directory structure by shell script:

$ cd ${WORK}/meta-renesas

$ sh \

meta-rcar-gen3/docs/sample/copyscript/copy_proprietary_softwares.sh \

${PKGS_DIR}
```

Note) Subdirectory is not supporting in \${PKGS_DIR}. Please store all packages on the root of \${PKGS_DIR}. Note) Please use regular alphanumeric file name ([A-Za-z0-9_] e.g.) for \${PKGS_DIR} due to restrictions of current copy script.

Step 6 execute source command

Please execute source command with oe-init-build-env for setting environment.

```
$ cd ${ WORK}
$ source poky/oe-init-build-env
```

Step 7 copy bblayers.conf and local.conf

Please copy configuration files from deliverables.

\$ cp \${ WORK} / meta-renesas / meta-rcar-gen3 / docs / sample / conf / < supported board name > / linaro-gcc / gfx-only / * . conf . / conf / .

Note) < supported board name > is the one of the following: salvator-x

Step 8 enable 3D Graphics package to install GSX modules

To enable 3D Graphics packages which use GSX, please overwrite local.conf as following instructions or modify local.conf as descriptions in \${WORK}/meta-renesas/meta-rear-gen3/README.proprietary

```
To install GSX kernel module:

Overwrite local.conf

$ cp conf/local-wayland.conf conf/local.conf (For Wayland)
```

Rev.2.19.0 Apr. 26, 2017

Step 9 select SoC

To select SoC, please set SOC_FAMILY to \${WORK}/build/conf/local.conf as SOC_FAMILY = "<soc type name>".

```
[H3]

SOC_FAMILY = "r8a7795"

[M3]

SOC_FAMILY = "r8a7796"
```

Step 10 building with bitbake

Please build as follows. The file system (core-image-weston-<supported board name>.tar.bz2) is created in \${WORK}/build/tmp/deploy/images/<supported board name>/ directory.

Note) < supported board name > is the one of the following: salvator-x

Note) Build by bitbake might need several hours under the influence of Linux Host PC performance and network environment.

Note) The bitbake downloads some package while building. Then the bitbake might stop for network timeout or link error. In this case, please get applicable package in \${WORK}/build/downloads directory whenever build stops by wget command, or please review timeout definitions of package download (wget, etc.) described in \${WORK}/poky/meta/conf/bitbake.conf.

\$ cd \${ WORK} / build
\$ bitbake core-image-weston (for Wayland)

3.3 In case of BSP Only

When you will not use neither proprietary Multimedia software nor licensed 3D Graphics software from Renesas, please execute as following steps.

Step 5 execute source command

Please execute source command with oe-init-build-env for setting environment.

```
$ cd ${ WORK}
$ source poky/oe-init-build-env
```

Step 6 copy bblayers.conf and local.conf

Please copy configuration files from deliverables.

```
$ cp ${ WORK} /meta-renesas/meta-rcar-gen3/docs/sample/conf/<supported
board name>/linaro-gcc/bsp/*.conf./
```

Note) < supported board name > is the one of the following: salvator-x

Note) core-image-weston is not supported even though local-wayland.conf is provided.

Step 7 select SoC

To select SoC, please set SOC FAMILY to \${WORK}/build/conf/local.conf as SOC FAMILY = "<soc type name>".

```
[H3]

SOC_FAMILY = "r8a7795"

[M3]

SOC_FAMILY = "r8a7796"
```

Step 8 building with bitbake

Please build as follows. The file system (core-image-minimal-<supported board name>.tar.bz2) is created in \${WORK}/build/tmp/deploy/images/<supported board name>/ directory.

Note) < supported board name > is the one of the following: salvator-x

Note) Build by bitbake might need several hours under the influence of Linux Host PC performance and network environment.

Note) The bitbake downloads some package while building. Then the bitbake might stop for network timeout or link error. In this case, please get applicable package in \${WORK}/build/downloads directory whenever build stops by wget command, or please review timeout definitions of package download (wget, etc.) described in \${WORK}/poky/meta/conf/bitbake.conf.

RENESAS

\$ cd \${ WORK} / build \$ bitbake core-image-minimal

4. Writing of IPL/Secure

4.1 Writing data

Filename	Program Top Address	Flash Save Address	Description		
bootparam_sa0.srec	0xE6320000	0x000000	Loader(Boot parameter)		
bl2- <board_name>.srec</board_name>	0xE6304000	0x040000	Loader		
cert_header_sa6.srec	0xE6320000	0x180000	Loader(Certification)		
bl31- <board_name>.srec</board_name>	0x44000000	0x1C0000	ARM Trusted Firmware		
tee- <board_name>.srec</board_name>	0x44100000	0x200000	OP-Tee		
u-boot-elf.srec	0x50000000	0x640000	U-Boot		

Note) Please refer to Chapter 5 for U-Boot.

4.2 Dip-Switch

a) QSPI Mode

Switch	Switch	Pin1	Pin2	Pin3	Pin4	Pin5	Pin6	Pin7	Pin8
Number	Name								
SW1	QSPI-A	ON	ON	ON	ON	ON	ON	-	-
SW2	QSPI-B	ON	ON	ON	ON	ON	ON	-	-
SW3	QSPI-C	set(OFF)		-	-	-	-	-	-
SW10	MODESW-A	Refer to 2.2			ON	OFF	ON	ON	

b) Hyper Flash Mode

Switch	Switch	Pin1	Pin2	Pin3	Pin4	Pin5	Pin6	Pin7	Pin8
Number	Name								
SW1	QSPI-A	OFF	OFF	OFF	OFF	OFF	OFF	-	-
SW2	QSPI-B	OFF	OFF	OFF	OFF	OFF	OFF	-	-
SW3	QSPI-C		set(ON)	-	-	-	-	-	-
SW10	MODESW-A	Refer to 2.2							

4.3 How to write

Please connect R-Car H3/M3 System Evaluation Board, Windows Host PC with terminal software for console and Linux Host PC.

In case of R-Car H3/M3, Ethernet connector is CN22, serial connector is CN25.

Step 1 connect cable

Connect USB Host connector of Windows Host PC that is virtual COM port to CN25 of R-Car H3/M3 System Evaluation Board with USB cable for displaying console.

Rev.2.19.0 Page 20 of 35



Step 2 setting the terminal software

Activate the Terminal Software on Windows Host PC. Configure the Terminal Software on Windows Host PC as followings. Please refer to Table 1 about the VCP driver for making a USB host connector into a virtual COM port

[setting value] baud rate 115200, 8bit data, parity none, stop 1 bit, flow control none.

Step 3 write data file to Hyper Flash

A file is written in Hyper Flash in the following procedures.

- Set dip switch "QSPI Mode".
- Reset board then start mini monitor.
- Set dip switch (Select Hyper Flash)

SW1: ALL OFF SW2: ALL OFF SW3: ON

Note) SW10 does not need to change.

• Execute xls2 command (load program to flash).

```
SALVATOR MiniMonitor V0.05 2015.08.25
Work Memory SystemRAM (H'E6328000-H'E632FFFF)
>xls2
==== Qspi/HyperFlash writing of Gen3 Board Command ========
Load Program to Spiflash
Writes to any of SPI address.
Please select,FlashMemory.

1: QspiFlash (U5: S25FS128S)
2: QspiFlash Board (CN3: S25FL512S)
3: HyperFlash (SiP internal)
Select (1-3)>
```

- Select HyperFlash. Input "3".
- After "SW31 ON! Setting OK? (Push Y key) [In the case of Kriek Board]" is displayed, input "y". (R-Car M3 only)
- After "SW1 SW2 All OFF! Setting OK? (Push Y key)" is displayed, input "y".
- After "SW3 ON! Setting OK? (Push Y key)" is displayed, input "y".
- After "Please Input Program Top Address" is displayed, input Program Top Address in 4.1 and "Enter".
- After "Please Input Qspi/HyperFlash Save Address" is displayed, input Flash Save Address in 4.1 and "Enter".
- After "Please send! ('.' & CR stop load)" is displayed, In case of Tera Term, transmit u-boot-elf.srec by "file -> file transmission(S)".
- If there are some data in writing area, "SPI Data Clear(H'FF) Check: H'00000000-0003FFFF Clear OK?(y/n)" is displayed. Then input "y".
- After "SAVE SPI-FLASH complete!" is displayed, the prompt returns. It means finish.
- Please repeat the xls2 command, if other files are written.
- · Power OFF
- Set dip switch to "Hyper Flash Mode".

Note) SW1, SW2, and SW3 are already Hyper Flash mode. Please set SW10.

Rev.2.19.0 Apr. 26, 2017

4.4 IPL/Secure write

Please write the file described in Chapter 4.1 to Hyper Flash.

The data file is stored in the $\{WORK\}/build/tmp/deploy/images/<board_name> directory.$



5. Confirm starting of U-Boot and Linux

Please connect R-Car H3/M3 System Evaluation Board, Windows Host PC with terminal software for console and Linux Host PC with TFTP and NFS server as Figure 1. Then please confirm normal starting of U-Boot and Linux with following step. Please refer to 2.2 for dip switch setting.

In case of R-Car H3/M3, Ethernet connector is CN22, serial connector is CN25, D-Sub connector is CN15.

Step 1 setting Linux Host PC

Please install TFTP server and NFS server in Linux Host PC with apt-get command and so on. Please set /etc/xinetd.d/tftp of TFTP server and /etc/exports of NFS server according to your environment.

Step 2 connect cable

Connect USB Host connector of Windows Host PC that is virtual COM port to CN25 of R-Car H3/M3 System Evaluation Board with USB cable for displaying console.

Step 3 setting the terminal software

Activate the Terminal Software on Windows Host PC. Configure the Terminal Software on Windows Host PC as followings. Please refer to Table 1 about the VCP driver for making a USB host connector into a virtual COM port.

[setting value] baud rate 115200, 8bit data, parity none, stop 1 bit, flow control none.

Step 4 write U-Boot to Hyper Flash

Filename	Program Top Address	Flash Save Address	Description	
u-boot-elf.srec	0x50000000	0x640000	U-Boot	

The data file is stored in the \${WORK}/build/tmp/deploy/images/<board_name> directory. Refer to Chapter 4.3 Step3 for write procedure.

Step 5 set U-Boot environment variables

Please refer to 2.2 for dip switch setting.

Please start U-Boot by board reset. Please set and save environment variable as follows.

- => setenv ethaddr xx:xx:xx:xx:xx:xx
- => setenv ipaddr 192.168.0.20
- => setenv serverip 192.168.0.1
- = > setenv bootcmd 'tftp 0x48080000 I mage; tftp 0x48000000 I mage-
- <SOC_FAMILY>-<Device_Tree>;booti 0x48080000 0x48000000'

Rev.2.19.0 Apr. 26, 2017 Page 23 of 35



Note) <SOC_FAMILY> is the following: r8a7795, r8a7796

Note) For R-Car H3 (SOC FAMILY r8a7795), the device trees are as follow:

- Image-r8a7795-es1-salvator-x.dtb: for R-Car H3 Ver.1.0 and Ver.1.1.
- Image-r8a7795-salvator-x.dtb: for R-Car H3 Ver.2.0.
- Image-r8a7795-salvator-xs.dtb: for R-Car H3 Ver.2.0 (RTP0RC7795SIPB0012S).

For R-Car M3 (SOC FAMILY r8a7796), the device trees are as follow:

- Image-r8a7796-salvator-x.dtb: for R-Car M3 Ver.1.0 and Ver.1.1.
- Image-r8a7796-salvator-xs.dtb: for R-Car M3 Ver.1.0 and Ver.1.1 (RTP0RC7795SIPB0012S).

Step 6 change the bootargs by U-Boot

To change bootargs which passed to the kernel in boot sequence, please modify it by "setenv bootargs" command of U-Boot.

```
=> setenv bootargs 'rw root=/dev/nfs nfsroot=192.168.0.1:/export/rfs ip=192.168.0.20'
```

Note) When the screen saver starts, the system halts. By adding "consoleblank=0" in bootargs, this problem is avoidable. Please refer to BSP release note for details.

Step 7 save environment variables

=> saveenv

Step 8 set file system

Please extract file system (core-image- weston-<supported board name>.tar.bz2). Please export /export directory of NFS server.

\$ mkdir /export/rfs

\$ cd /export/rfs

\$ sudo tar xvf core-image-weston(minimal)-<supported board name>.tar.bz2

Note) <supported board name> is the following: salvator-x.

Step 9 start Linux

After board reset, U-Boot is started. After countdown, Linux boot messages are displayed. Please confirm login prompt after Linux boot messages.

Rev.2.19.0 Page 24 of 35

Note) When MAC Address is rewritten, it is necessary to reset.

Note) In core-image-weston, please connect input device (keyboard, mouse) to USB port (CN10). In R-Car M3, only CN10 of USB2_1 port can be used.

Rev.2.19.0 Page 25 of 35 Apr. 26, 2017

Exporting Toolchains 6.

Please refer Documents from Yocto Project to export Toolchains such as http://www.yoctoproject.org/docs/current/adt-manual/adt-manual.html.

And please use build target of bitbake as "core-image-weston-sdk -c populate sdk" to generate package.

Note) When you use "ld" directly but not via gcc (in case of building Kernel, Driver or U-Boot), please disable LDFLAGS with 'unset LDFLAGS'. Furthermore, in kernel build, 'make menuconfig' occurs error by neurses. In this case, please disable PKG CONFIG PATH with 'unset PKG CONFIG PATH'.

Note) Please do not use same shell environment to other compilation/debugging purpose (also make menuconfig of linux kernel, e.g.) but cross compilation for R-Car H3/M3 which shell environment with "source" command to setup environment variables for the SDK. Because some environment variables for cross compilation interferes execution of other tools on the same shell environment.

Example of instruction:

In following examples, it's assumed that it's already extracted and prepared recipe environment such as in the instructions of Section 3 (must done just before execution of bitbake, at least). You may reuse \${WORK}/build while you reuse same configuration after executing bitbake as in Section 3 for this purpose.

Step 1 configure architectures of Host PC which are installed this toolchain

Please modify SDKMACHINE description on \${WORK}/build/conf/local.conf

On \${ WORK} / build/conf/local.conf

```
# This variable specified the architecture to build SDK/ADT items for and means
# you can build the SDK packages for architectures other than the machine you are
# running the build on (i.e. building i686 packages on an x86_64 host.
# Supported values are i686 and x86_64
#SDKMACHINE ?= "i686"
SDKMACHINE ?= "x86_64"
```

Note) 32bit Ubuntu 14.04 is not supported.

Page 26 of 35

Step 2 building toolchain package with bitbake

```
$ cd ${ WORK} / build
$ bitbake core-image-weston-sdk -c populate_sdk
$ cp tmp/deploy/sdk/poky-glibc-x86_64-core-image-weston-sdk- aarch64-
toolchain-2.1.2.sh (shared dir. where able to access from each Host PCs)
```

Note) Please perform "bitbake core-image-minimal -c populate sdk" in BSP Only.

Step 3 Install toolchain on each Host PCs

```
$ sudo (shared dir. where able to access from each Host PCs)/poky-glibc-x86_64-core-image-weston-sdk-aarch64-toolchain-2.1.2.sh

[sudo] password for (INSTALL person): (password of your account)
Enter target directory for SDK (default: /opt/poky/2.1.2): (just a return)
Extracting SDK...done
Setting it up...done
```

Step 4 setup environment variables for each compilation on each Host PCs

SDK has been successfully set up and is ready to be used.

Please setup environment variables as follows or integrate set-up sequence into your build script or Makefile.

```
$ cd (Your working directory)
$ source /opt/poky/2.1.2/environment-setup-aarch64-poky-linux
$ export LDFLAGS=""
$ ${CC} (Your source code).c .....
```

7. Memory map

Following Figure 2 to Figure 6 show memory map of this R-Car H3/M3 Linux BSP package.

Note)

- The volume of SDRAM is total 4GB.
- 2GB from 0x00 4000 0000 to 0x00 BFFF FFFF is a shadow area from 0x04 0000 0000 to 0x04 7FFF FFFF.
- The following regions are used as a secure region. It doesn't allow U-Boot and kernel to access those regions.
 - ➤ 63MB from 0x00_43F0_0000 to 0x00_47DF_FFFF in SDRAM
 - ➤ 16KB from 0x00 E630 0000 to 0x00 E630 3FFF in System RAM
- In case the configuration of BSP + 3D Graphics + Multimedia package, it doesn't allow to store any data in "CMA for Lossy comp" (default: 0x00_5400_0000 0x00_56FF_FFFF) region which is for media playback before kernel boots up. Any data stored in this region are read through the decompression module in AXI-Bus, so a normal data (not a decoded frame) will be corrupted.

Rev.2.19.0 Page 28 of 35

Apr. 26, 2017

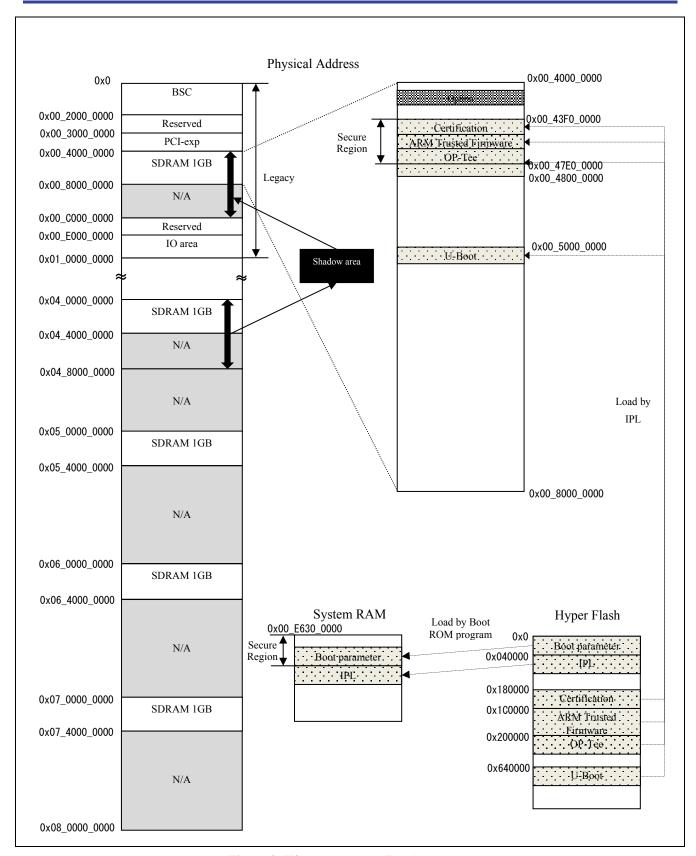


Figure 2. H3 memory map (Boot)

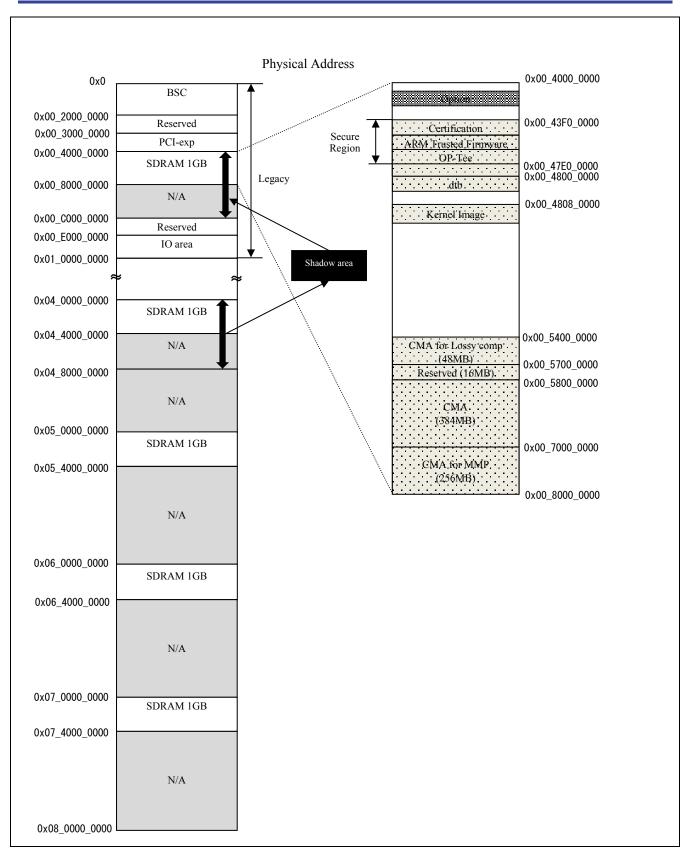


Figure 3. H3 memory map (Linux)

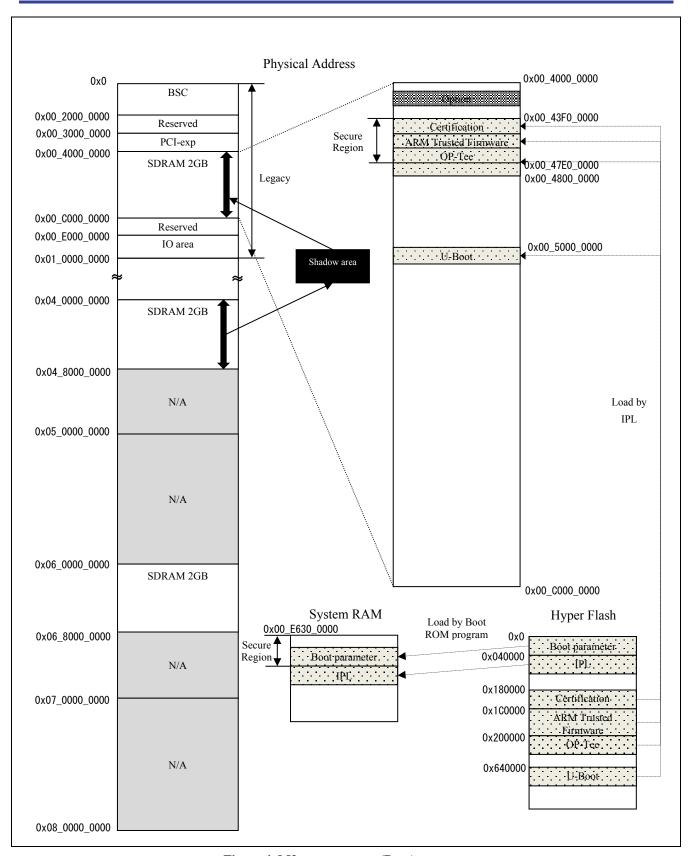


Figure 4. M3 memory map (Boot)

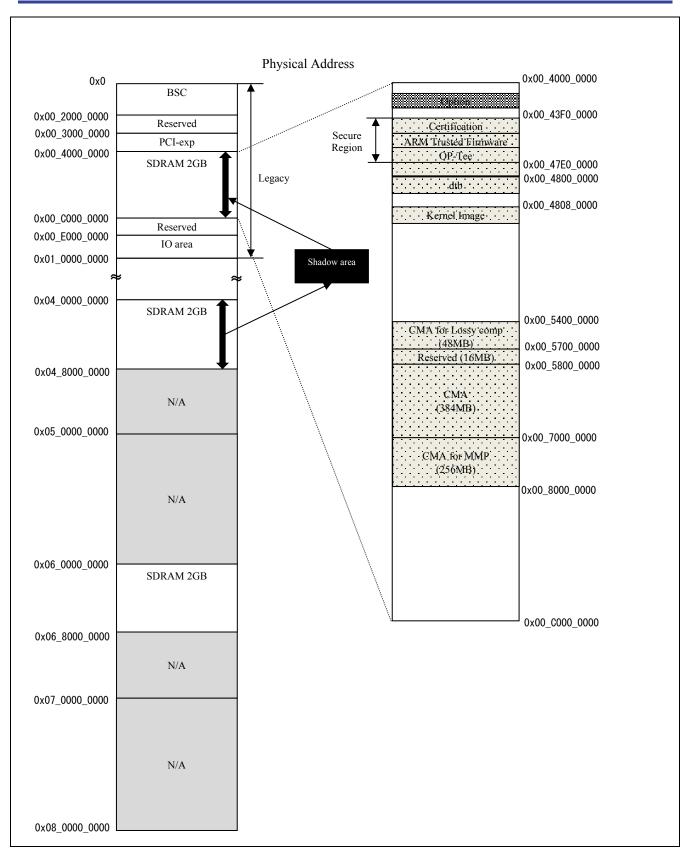


Figure 5. M3 memory map (Linux)

Note)

- Kernel region is assigned by Kernel device tree arch/arm64/boot/dts/renesas/xxx.dts and totally mapped to 4GB.
- Kernel region consists of 4 parts: (R-Car H3)
 - > 896MB from 0x00 4800 0000 to 0x00 7FFF FFFF
 - ➤ 1GB from 0x05 0000 0000 to 0x05 3FFF FFFF
 - ➤ 1GB from 0x06 0000 0000 to 0x06 3FFF FFFF
 - ➤ 1GB from 0x07_0000_0000 to 0x07_3FFF_FFFF
- Kernel region consists of 2 parts: (R-Car M3)
 - > 1920MB from 0x00_4800_0000 to 0x00_BFFF_FFFF
 - 2GB from 0x06_0000_0000 to 0x06_7FFF_FFFF

There are three types of CMA regions.

They are defined in device tree (arch/arm64/boot/dts/renesas/xxxx.dts).

Default CMA region: It is for kernel, general drivers and multimedia package.

```
linux,cma {
    compatible = "shared-dma-pool";
    reusable;
    reg = <0x00000000 0xXXXXXXXX 0x0 0xYYYYYYYY;
    linux,cma-default;
};

0xXXXXXXXX is start address of CMA region.
0xYYYYYYYY is size of CMA region.
```

Note)

- 128 MB in this CMA (384MB) is reserved for kernel and general drivers, and the remaining 256 MB is reserved for multimedia package.
- The CMA region can be adjusted by changing the start address and the size.
- Should take care of the lack of memory allocated by kernel and general drivers when reducing the region size.
- CMA region for MMP: It is for multimedia package (specific H/Ws).

```
mmp_reserved: linux,multimedia {
    compatible = "shared-dma-pool";
    reusable;
    reg = <0x00000000 0xXXXXXXXX 0x0 0xYYYYYYYY>;
};

0xXXXXXXXX is start address of CMA region.
0xYYYYYYYY is size of CMA region.
```

• Refer to User's manual of Memory Manager in order to change CMA region for MMP.

Rev.2.19.0 Apr. 26, 2017

Note)

> CMA region for Lossy comp: It is for storing data compressed by Frame Compression Near Lossless (FCNL) for media playback.

```
lossy_decompress: linux,lossy_decompress {
    no-map;
    reg = <0x00000000 0xXXXXXXXX 0x0 0xYYYYYYYY>;
};

0xXXXXXXXX is start address of CMA region.
0xYYYYYYYY is size of CMA region.
Note)
```

• Refer to User's manual of IPL in order to change CMA region for Lossy comp.

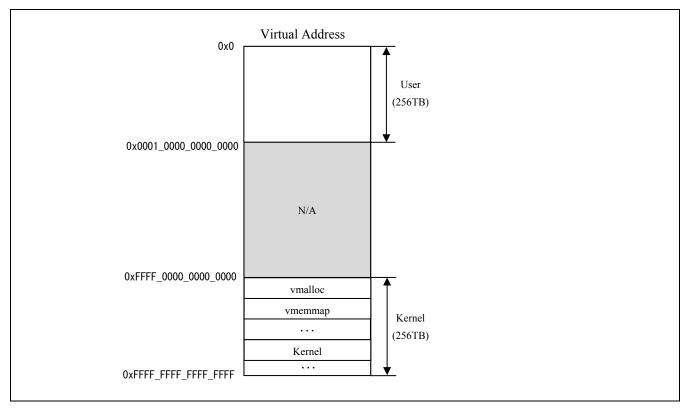


Figure 6. H3/M3 memory map (Virtual)

Note)

- Kernel uses 4KB page size (VA_BITS=48) and 4 levels of translation tables. Both regions of User and Kernel are 256TB. Refer to Documentation/arm64/memory.txt.
- Detail information about kernel memory map in virtual address space, refer to User's manual of Kernel.

8. U-Boot command

Please refer to U-Boot user's manual about available U-Boot command for R-Car H3/M3 Linux BSP. The help or "?" command shows U-Boot command list, but be careful that it includes some unsupported command.

REVISION HISTORY	Linux Interface Specification Yocto recipe Start-Up Guide
	User's Manual: Software

Rev.	Date		Description				
		Page	Page Summary				
0.10	Sep 07. 2015	_	First Edition for Yocto Recipe Package with YP1.8, based on Start-Up Guide Rev 1.3 for Kernel 3.4 LTSI				
0.20	Sep 30. 2015	2	1 Modified URL of U-Boot and Linux source code.				
		6	3 Deleted description about core-image-x11				
		6	3 step2 Changed git repository URL				
		9	3.2 Added note about not support 3D graphics package				
			3.2 step5,7 Changed command process				
		12	4.1 Changed U-Boot filename. u-boot.srec -> u-boot-elf.srec				
		21, 22	7 Modified memory map (Fig2, 3)				
0.30	Oct 30 2015	2	1.1 Modified document version				
		3	2.1 Updated table1				
		4	2.1 Updated Figure1				
		7	3 Modified checkout commit id				
			3 step4 Updated apply patch command				
		8-12	3.1 Added description build procedure for MMP and 3D Graphics				
		14	4.4 Deleted note				
		18	5 step6 Added mem=2048 to bootargs				
			5 step8 Added note				
		19-21	6 Modified SDK revision 1.8 -> 1.8.1				
		22	7 Modified the description of the address range.				
	0x00_C000_0000 -> 0x00_BFFF_FFF		0x00_C000_0000 -> 0x00_BFFF_FFFF				
			7 Modified the address range and size of a secure region.				
		23	7 Modified the address of System RAM.				
			0x00_E630_0000 -> 0x00_E632_0000				
			7 Modified the load destination of Certification in HyperFlash.				
24, 25 7 Modified me 7 Added note			System RAM -> SDRAM				
		24, 25	7 Modified memory map (Fig3) and update note about CMA				
			7 Added note about specifying mem=2048M				
			7 Added note about 3D graphics region				
		26	7 Separated virtual memory map (Fig4) and note about virtual memory				
0.40	Nov 27 2015	7	3 Modified checkout commit id				
		- 10	3 step4 Updated apply patch command				
		18	5 step6 Added note about adding consoleblank=0 in bootargs				
			5 step7 Added description saveenv command 5 step9 Modified start Linux procedure				
0.50	D 05 0045	_					
0.50	Dec 25 2015	6	3 step1 added python-crypto				
		7	3 setp2 added meta-openembedded				
		7	3 Modified checkout commit id				
		17	5 step5 deleted note				
0.01	105.0010	18	5 step9 added USB channel number				
0.61	Jan 25 2016	7	3 Modified checkout commit id				
	3 step4 Changed patch command						
		10	3.1 step10 Fixed typo in captor name				
		40	3.1 step10 Deleted note for mem=2048M in bootargs				
		12	3.2 step9 Deleted note for mem=2048M in bootargs				

		14	4.1 Changed Hex notation. 0xXXXX -> H'XXXX					
		18	5 step6 Deleted mem=2048M in bootargs					
		10	5 step9 Add note about XDG_RUNTIME_DIR					
		19-21	Changed SDK version to 2.0 from 1.8.1					
		20	7					
0.70	Fab 25 2016		6 step3 Add note about overwrite installation					
0.70	Feb 25 2016	2	1.1 Modified document version					
		7	3 Modified checkout commit id					
		8	3.1 step5 Renewed description					
		11	3.2 step5 Renewed description					
		18	5 step8 Deleted console setting from bootargs					
			5 step9 Add note about writing MAC address					
		19-21	Changed SDK version to 2.0.1 from 2.0					
0.80	2.2 Add R-Car H3 Ver.1.1 and changed setting value of SW11-4pin in Ver.1.0							
		8	3 Modified checkout commit id					
		10,11	3.1 step9 Add Type name of MMP and dependence package list					
		18	5 Deleted note					
		25	7 Modified memory map (Fig3) and remove the 3D Graphics specific region					
		26	Deleted the description of "mem=" and update Kernel region					
0.90 Apr 25 2016 all Added description			Added description for R-Car M3. For example, R-Car H3 -> R-Car H3/M3					
		2	1.1 Modified document version					
			1.1 Deleted "R-Car Series, 3 rd Generation Electorical Characteristics"					
		6	2.2 Add table4 for R-Car M3					
		8	3 Modified checkout commit id					
		9	3.1 Added note for R-Car M3					
		11-12	3.1 step9 Updated Multi Media Package list					
		13	3.1 step10 Added select SoC					
		15	3.2 step9 Added select SoC					
		16	3.3 step7 Added select SoC					
		21	5 step5 Changed description setenv command, and added note for SOC_FAMILY					
		27,28	Modified memory map(Fig2 and Fig3) of H3					
		29,30	Added memory map(Fig4 and Fig5) of M3					
		31	Added description of M3 kernel region					
		32	Added description of CMA region for Lossy comp					
2.9.0	May 25 2016	_	Changed Revision number rule. Document revision number is Yocto Recipe version.					
		6	2.2 Modify table4. RCar M3: DDR1600 -> DDR3200					
		8	3 Modified checkout commit id					
		9	3.1 deleted note for R-Car M3					
		11-12	3.1 step9 Fix TYPO and added aacPlus V2 decoder, ADSP, Ether-AVB					
2.10.0	Jun 27 2016	2	1 Updated linux source code URL					
10.0	· ·		3 Modified checkout commit id					
		19	4 step3 added message for SW31 in R-Car M3					
		23-25	6 Changed version of SDK. 2.0.1 -> 2.0.2					
		26	Added note of "CMA for Lossy comp" region					
			· · · ·					
		26,27, 29	Added description of 8KB Secure region from 0xE6300000					
			Modified memory map(Fig2 and Fig4) of H3/M3					

		32	Changed virtual address appea from 20 hit to 49 hit					
		32	Changed virtual address space from 39-bit to 48-bit Modified memory map(Fig 6)					
2.11.0	Jul 25 2016	2	1.1 Modified Reference					
2.11.0	001 20 20 10	8	3 Modified checkout commit id					
		10						
		11-14	3 step9 Updated standard multimedia package table 3 step9 Updated optional multimedia package table					
			4.2 Updated Dip-Switch setting for R-Car H3 Ver.1.1 and M3 Ver.1.0					
		20	4.2 Updated Dip-Switch setting for R-Car H3 Ver.1.1 and M3 Ver.1.0 5 Added description about refer to Dip-Switch setting					
		23	-					
		24	5 step9 Modified note for USB connector. R-Car M3 support only CN10 of USB2_2					
		23-24	5 Deleted description of 32bit environment					
		25-26	6 Deleted description of 32bit SDK					
		33	7 Updated device tree source code of CMA region for Lossy comp					
2.12.0	Aug 25 2016	1 Updated linux source code URL						
		2	1.1 Modified Reference					
		3	2.1 Updated table 1					
		5	2.2 Updated table 2					
		7	3 step1 Added note about git config					
		8	3 step3 Modified checkout commit id					
		11-14	3 step9 Updated optional multimedia package table					
		25	6 Updated note about environment variables					
		25-26	6 Deleted description of 32bit SDK					
2.15.0	2.15.0 Dec 07, 2016		2.2 Added note for setting of dip switch					
		Table4 Added "*1" for SW11-pin4.						
		8	3 Modified checkout commit id					
		11-14	Fixed Type name of Dolby(R) Digital decoder middleware library					
		20	4.1 Changed U-Boot Program Top Address					
		23	5 Step 4 Changed U-Boot Program Top Address					
		23-24	5 Step 5 Changed dtb filename.					
			Added notes about R-Car H3 device trees names.					
		27	6 Step 2,3,4 Updated Yocto Project version to 2.1.2					
28-34			7 Updated Memory map corresponding to new BSP v3.4.0					
2.16.0	Jan 27, 2017	8	3 Modified checkout commit id					
		10	3 step9 Updated to use H263 Dec as example					
·		11-14	3 step9 Updated optional multimedia package table to add H263 Dec					
		13	3 step9 Changed description "Independence package" to "Dependent package"					
		25	5 step9 Changed XDG_RUNTIME_DIR value to XDG_RUNTIME_DIR=/run/user/0					
		26	6 step1 Fixed typo: SDK_MACHINE -> SDKMACHINE					
2.17.0	Mar 30, 2017	-	Changed description of variables from \$foo to \${foo}					
		2	1.1 Updated related documents.					
			Added R-CarH3-SiP/M3-SiP System Evaluation Board Salvator-XS Hardware Manual					
		5	2.2 Added Setting of Dip switches for R-Car H3 Ver.2.0 (Salvator-X/XS board)					
		8	3 Modified checkout commit id					
		20	4.1 Change address format from H'xxxx to 0xxxxx					
			Changed bl2- <board_name>.srec Program Top Address.</board_name>					
24 Deleted notes about R-Car H3 device trees names.								
	<u> </u>	J	l .					

		25	5 step9 Corrected USB port of M3.	
			Deleted note about setting XDG_RUNTIME_DIR.	
		28	7 Expanded secure regions in System RAM.	
		33	7 Clarified the use of the default CMA region.	
2.19.0 Apr 26, 2017		-	Unified the Chip version "Ver/ES/WS" to "Ver."	
		-	Changed "U-boot" to "U-Boot".	
		5-6	2.2 Updated Setting of Dip switches for R-Car M3 Ver.1.1 (Salvator-X/XS board)	
		8	3 Modified checkout commit id.	
		16	Changed description of variables from \$PKGS_DIR to \${PKGS_DIR}.	
		24	Updated notes about R-Car M3 device trees names.	

Linux Interface Specification Yocto recipe Start-Up Guide

User's Manual: Software

Publication Date: Rev.2.19.0 Apr. 26, 2017

Published by: Renesas Electronics Corporation



SALES OFFICES

Renesas Electronics Corporation

http://www.renesas.com

Refer to "http://www.renesas.com/" for the latest and detailed information.

Renesas Electronics America Inc. 2801 Scott Boulevard Santa Clara, CA 95050-2549, U.S.A. Tel: +1-408-588-6000, Fax: +1-408-588-6130

Renesas Electronics Canada Limited 9251 Yonge Street, Suite 8309 Richmond Hill, Ontario Canada L4C 9T3 Tel: +1-905-237-2004

Renesas Electronics Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K
Tel: +44-1628-585-100, Fax: +44-1628-585-900

Renesas Electronics Europe GmbH

Arcadiastrasse 10, 40472 Düsseldorf, Germany Tel: +49-211-6503-0, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd. Room 1709, Quantum Plaza, No.27 ZhiChunLu Haidian District, Beijing 100191, P.R.China Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.
Unit 301, Tower A, Central Towers, 555 Langao Road, Putuo District, Shanghai, P. R. China 200333 Tel: +86-21-2226-0888, Fax: +86-21-2226-0999

Renesas Electronics Hong Kong Limited
Unit 1601-1611, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong Tel: +852-2265-6688, Fax: +852 2886-9022

Renesas Electronics Taiwan Co., Ltd. 13F, No. 363, Fu Shing North Road, Taipei 10543, Taiwan Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd.
80 Bendemeer Road, Unit #06-02 Hyflux Innovation Centre, Singapore 339949
Tel: +65-6213-0200, Fax: +65-6213-0300

Renesas Electronics Malaysia Sdn.Bhd.
Unit 1207, Block B, Menara Amcorp, Amcorp Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: +60-3-7955-9390, Fax: +60-3-7955-9510

Renesas Electronics India Pvt. Ltd. No.777C, 100 Feet Road, HAL II Stage, Indiranagar, Bangalore, India Tel: +91-80-67208700, Fax: +91-80-67208777

Renesas Electronics Korea Co., Ltd. 12F., 234 Teheran-ro, Gangnam-Gu, Seoul, 135-080, Korea Tel: +82-2-558-3737, Fax: +82-2-558-5141

© 2017 Renesas Electronics Corporation. All rights reserved.



営業お問合せ窓口

http://www.renesas.com

営業お問合せ窓口の住所は変更になることがあります。最新情報につきましては、弊社ホームページをご覧ください。

ルネサス エレクトロニクス株式会社 〒135-0061 東京都江東区豊洲3-2-24(豊洲フォレシア)

統合お問合せ窓口:https://www.renesas.com/contact/		

Linux Interface Specification Yocto recipe Start-Up Guide

